

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

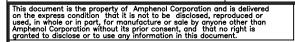
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





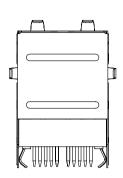




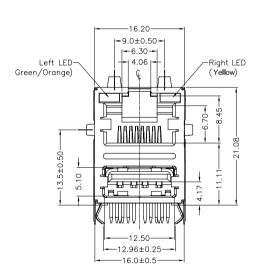
## CUSTOMER DRAWING

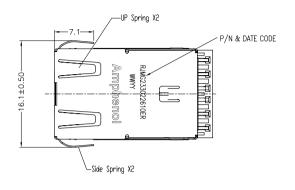
		REVISIONS		
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
Α	/	PRELINIMARY RELEASED	Jun.01.09	Greg L

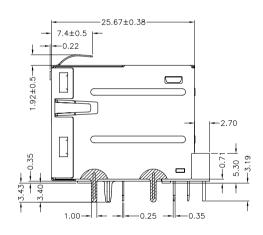


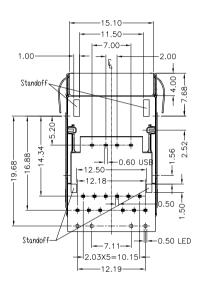


D

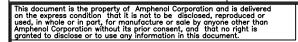








TOLERANCE m/m APPROVALS		DATE	TITLE										
	±0.30	Stone Lee		Jun.01.09	R	Jmag 1000 Base—T			Amphenol <sup>®</sup>				
'''''	±0.25 ±0.15	CHECKED Jason Zhan J		Jun.01.09	D	J Over USB		Amp	henol	East A	۱sia	Ltd	5
x.xxx		APPROVED		Jun.01.09	1\1	1 Over O3D							
ANGULAR ±2°		oreg L	1		CIZE	DADT NO	L DD4	SCALE	N.A.	SHEET	1 OF	3	
UNLESS OTH	ERWISE SPECIFIED	$\bigoplus \bigoplus$	UNIT	MM	SIZE A3	PART NO. RJMG233022610ER	DRA	WING NO		22610	ER	REV. A	



## CUSTOMER DRAWING

L1 ←

L2 ←

INPUT

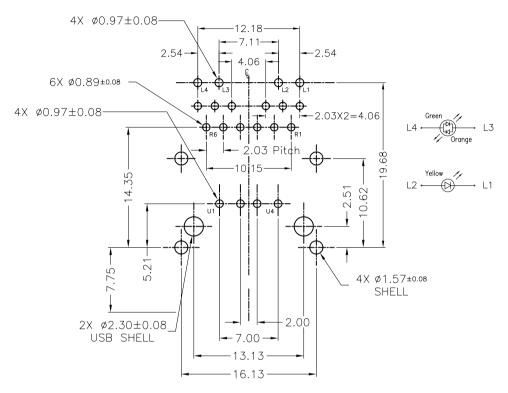
R11 ←

Yellow

	REVISIONS												
SYM	ECN No.	DESCRIPTION	DATE	APPROVED									
Α		PRELINIMARY RELEASED	Jun.01.09	Greg L									

OUTPUT

C1



RECOMMENDED PCB LAYOUT
COMPONENT SIDE
PCB THICKNESS: 1.60mm
ALL DIMENSION TOLERANCE ARE ±0.05
UNLESS OTHERWISE SPECIFIED



#### LED PERFORMANCE

Emitted Color	Yellow	Green/Orange					
Wavelength	585nm	568/610nm					
Forward Current	30mA Max.	30mA Max.					
Reverse Current	100uA Max. @ 5V	100uA Max. @ 5V					
Forward Volt. Max.	2.2 VDC	2.2 VDC					

han	Jun.01.09	RJ Over USB	/	Amphe	enol East Asia Ltd
ee Jun.01.09		RJmag 1000 Base—T			mphenol®
_S	DATE	TITLE		<b>A</b>	
		SHIELD		Z, GROI	UND
	3 Green	Orange 1000pF,	2KV #		
R'					C8
	8 -	1:1	2		C7
R R:	2				C5
	3 -	1:1	2		C4
	6 · · · · · · · · · · · · · · · · · · ·				C6
	4	1:1			C3
R1:					C2

1 : 1

 $75\Omega$ 

	TOLER	RANCE m/m	APPROVALS		DATE	TITLE							•	
	х.	±0.30	DRAWN St	Stone Lee Juliecked Jason Zhan Juliecked		Jun.01.09	R	Jmag 1000 Base-T		A	mb	ohei	10	<b>"</b>
	x.x x.xx	±0.25 ±0.15	CHECKED J			Jun.01.09	D	J Over USB		Amp	henol	East A	۱sia	Ltd
	x.xxx	±0.08	APPROVED (			Jun.01.09	1\	1 Over O3D				1		
	ANGULAR ±2°		1							SCALE	N.A.	SHEET	<u>2                                    </u>	F 3
H				Ф	UNIT		SIZE	PART NO.	DR/	awing no.				REV.
	UNLESS OT	HERWISE SPECIFIED		<b>⊕</b>		ММ	A3	RJMG233022610ER		RJMO	32330:	226101	<u>-</u> R	А

This document is the property of Amphenol Corporation and is delivered on the express condition that it is not to be disclosed, reproduced or used, in whole or in part, for manufacture or sale by anyone other than Amphenol Corporation without its prior consent, and that no right is granted to disclose or to use any information in this document.

### CUSTOMER DRAWING

		REVISIONS		
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
Α		PRELINIMARY RELEASED	Jun.01.09	Greg L

#### MATERIALS:

#### 1.Terminal Parts:

1.1.RJ Terminal :Phosphor Bronze,Thickness=0.30mm

Finish:30u" gold on contact area,100u" min. tin on solder tail area,underplating 50~100u" Nickel over all.

1.2.RJ input Terminal :Brass,Thickness=0.35mm Finish:100u" min. tin over 50~100u" Nickel.

1.3.Module Terminal :Brass,Thickness=0.25mm
Finish:100u" min. tin over 50~100u" Nickel.

1.4.USB Terminal: Phosphor Bronze, Thickness=0.25mm Finish:15u" gold on contact area,100u" min. tin on solder tail area,underplating 50~100u" Nickel over all.

#### 2.Plastic Parts:

2.1. Housing: Thermoplastic, PBT, Black; UL FILE No.: E130155

Grade:1410, Flame Class:UL94 V-0

2.2.Coil Case: Thermoplastic, PBT, UL FILE No.: E130155

Grade:1410, Flame Class:UL94 V-0

2.3.Spacer: Thermoplastic, PBT, UL FILE No.: E130155

Grade:1410, Flame Class:UL94 V-0

#### 3.Shell Parts:

3.1.Shell : Stainless,Thickness=0.20mm, Grounding Leg : Pre-soldering.

3.2.Grounding Leg of USB: Brass, Thickness=0.25mm Finish: 100m? min. Tin over 50~100m? min. Nickel

#### OTHERS:

1.Operating Temperature: 0°C TO +70°C

2.Storage Temperature : -40°C TO +85°C

3.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS

PART 68 , SUBPART F



# ELECTRICAL SPECIFICATION (@25°C) CONNECTOR PERFORMANCE

PARAMETER	LIMITS (MAX. OR MIN.)	FREQUENCY RANGE/ TEST CONDITIONS
INSERTION LOSS (RX/TX)	-1.0dB MAX.	1-100 MHz
RETURN LOSS (RX/TX)	-18dB MIN. -16dB MIN. -12dB MIN. -10dB MIN.	1-30 MHz 30-60 MHz 60-80 MHz 80-100 MHz
CM-CM REJECTION	-30dB MIN.	1-100 MHz
CROSSTALK ISOLATION (RX/TX)	-30dB MIN.	1-100 MHz
HIPOT (ISOLATION)	1.5kVrms MIN.	60 Sec.
OCL	350uH MIN.	100KHz 100mV 8mA
TURN RATIO	1:1±5%	

TOLER	ANCE m/m	APPROVALS		DATE	TITLE		_				<b>.</b> .		
x.	±0.30	Stone Lee J		Jun.01.09	R	Jmag 1000 Base—T		Ampheno				•	
x.x	±0.25	CHECKED						Amphenol East Asia					L
x.xx	±0.15	Jason Zhan		Jun.01.09	RJ Over USB				Amphenoi Last Asia				
x.xxx	±0.08	APPROVED Greg L		Jun.01.09				SCALE	N.A.	SHEET	3 0	 F 3	l
ANGULAF	R ±2°		UNIT		SIZE	PART NO.	DR/	WING NO.		SHEET		REV.	
UNLESS OTH	HERWISE SPECIFIED			MM	А3	RJMG233022610ER		RJMG	23302	22610	ER	Α	